

# 承認書 Specification For Approval

| Customer    | :(客戶)            |           |           |       |
|-------------|------------------|-----------|-----------|-------|
| Descriptio  | <b>n:</b> (產品描述) | SMDLED    | 02012     |       |
| Part numbe  | <b>?:</b> (產品型號) | TJ-S2012G | 08HQYJY-A | 43    |
| Date:       | (日期)             |           |           |       |
| Approved B  | <b>y:</b> (客戶承認) |           |           |       |
| Prepared By | [:(我司承認)         |           |           |       |
|             | Approval         | Check     | Design    | Sales |
|             | 核准               | 審核        | 製作        | 業務    |

 Customer Service Hotline:
 400-676-8616

 TEL:
 0769-8662 5999
 0769-8200 2226

 E-MIAL:
 dg@togialed.com

FAX: 0769-8200 2227 WEB: www.togialed.com



#### Features

 $2.0 \text{mm} \times 1.25 \text{mm}$  SMT LED, 0.8 mm thickness

Low power consumption

Wide view angle

Package: 3000pcs/reel

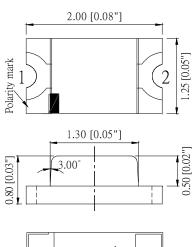
**RoHS** Compliant

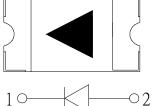
#### Applications

Ideal for back light and indicator

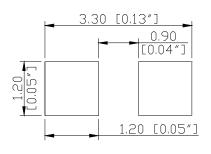
Various colors and lens types available

#### Package outlines





## **Recommend Pad Layout**





| Part No.            | Emitted color | Dice      | Lens color        |
|---------------------|---------------|-----------|-------------------|
| TJ-S2012G08HQYJY-A3 | Green         | InGaN/GaN | Water transparent |

Notes:

- 1. All dimensions are in millimeters (inches);
- 2. Tolerances are  $\pm 0.1$ mm (0.004inch) unless otherwise noted.



# Absolute Maximum Ratings (TA=25°C)

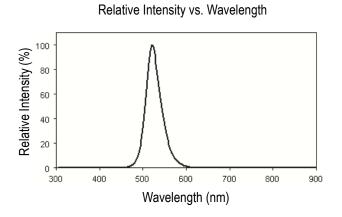
| Parameter                              | Symbol | Value    | Unit |
|--|--------|----------|------|
| Forward current                        | lf     | 20       | mA   |
| Reverse voltage                        | Vr     | 5        | V    |
| Power dissipation                      | Pd     | 108      | mW   |
| Operating temperature                  | Тор    | -40 ~+80 | °C   |
| Storage temperature                    | Tstg   | -40 ~+85 | °C   |
| Peak pulsing current (1/8 duty f=1kHz) | lfp    | 125      | mA   |

# Electro-Optical Characteristics (TA=25°C)

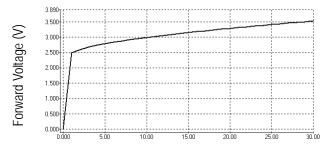
| Parameter                   | Test<br>Condition | Symbol                   | Value |     |     | Unit |
|-----------------------------|-------------------|--------------------------|-------|-----|-----|------|
| Farameter                   |                   |                          | Min   | Тур | Max | Unit |
| Wavelength at peak emission | lf=20mA           | λp                       |       | 530 |     | nm   |
| Spectral half bandwidth     | lf=20mA           | $\bigtriangleup \lambda$ |       | 18  |     | nm   |
| Dominant wavelength         | lf=20mA           | $\lambda$ d              | 515   |     | 535 | nm   |
| Forward voltage             | lf=20mA           | Vf                       | 2.7   |     | 3.4 | V    |
| Luminous intensity          | lf=20mA           | lv                       | 400   |     | 800 | mcd  |
| Viewing angle at 50% Iv     | lf=10mA           | <b>2</b> θ <b>1/2</b>    |       | 120 |     | Deg  |
| Reverse current             | Vr=5V             | lr                       |       |     | 10  | μA   |



## **Optical Characteristic Curves**

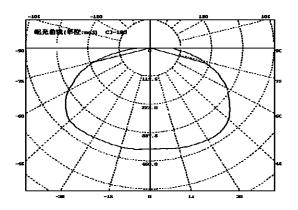


Forward Current vs. Forward Voltage



Forward Current (mA)

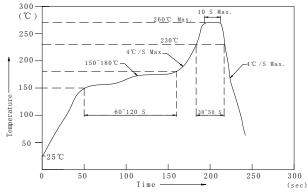
**Directive Characteristics** 





## **Reflow Profile**





Notes:

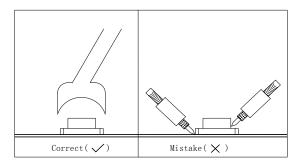
- 1.We recommend the reflow temperature 245°C(±5°C).the maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3.Number of reflow process shall be 2 times or less.

#### ■Soldering iron

Basic spec is ≤ 5sec when  $320^{\circ}C(\pm 20^{\circ}C)$ . If temperature is higher, time should be shorter(+10°C → -1sec ).Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under  $350^{\circ}C$ .

#### Rework

- 1.Customer must finish rework within 5 sec under  $340^{\circ}$ C.
- 2. The head of iron cannot touch copper foil
- 3. Twin-head type is preferred.

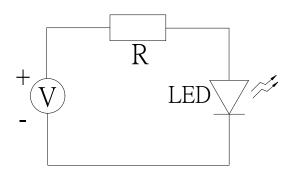


Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.



Test circuit and handling precautions

Test circuit



- Handling precautions
- 1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

**Temperature** : 5 °C ~ 30 °C (41 °F ~ 86 °F )

- 2.2 Shelf life in sealed bag: 12 month at <5°C~30°C and <30% R.H. after the package is Opened, the products should be used within a week or they should be keeping to stored at ≤20 R.H. with zip-lock sealed.
- 3. Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as followings:

- 3.1 60 $\pm$ 3°C x(12~24hrs) and <5%RH, taped reel type
- 3.2 100 $\pm$ 3°C x(45min~1hr), bulk type
- 3.3 130 $\pm$ 3°C x(15~30min), bulk type



# Test items and results of reliability

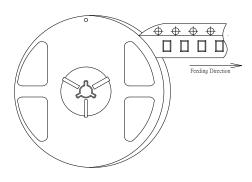
| Туре                      | Test Item                    | Test Conditions Note                          |           | Number of<br>Damaged |
|---------------------------|------------------------------|---|-----------|----------------------|
| Environmental<br>Sequence | Temperature Cycle            | -40°C 30min<br>↑ →(25°C/5min)↓<br>100°C 30min | 100 cycle | 0/22                 |
|                           | Thermal Shock                | -40℃ 15min<br>↑↓<br>100℃ 15min                | 100 cycle | 0/22                 |
|                           | High Humidity Heat Cycle     | 30℃⇔ 65℃<br>90%RH 24hrs/1cycle                | 10 cycle  | 0/22                 |
|                           | High Temperature Storage     | Ta=100℃                                       | 1000 hrs  | 0/22                 |
|                           | Humidity Heat Storage        | Ta=60℃<br>RH=95%                              | 1000 hrs  | 0/22                 |
|                           | Low Temperature Storage      | <b>Ta=-40</b> ℃                               | 1000 hrs  | 0/22                 |
| Operation<br>Sequence     | Life Test                    | Ta=25℃<br>IF=20mA                             | 1000 hrs  | 0/22                 |
|                           | High Humidity Heat Life Test | 60℃ RH=95%<br>IF=10mA                         | 500 hrs   | 0/22                 |
|                           | Low Temperature Life Test    | Ta=-20℃<br>IF=20mA                            | 1000 hrs  | 0/22                 |

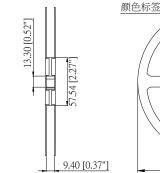


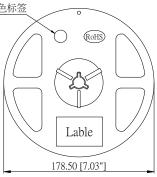
## 2012 Series SMD Chip LED Lamps Packaging Specifications

**Feeding Direction** 

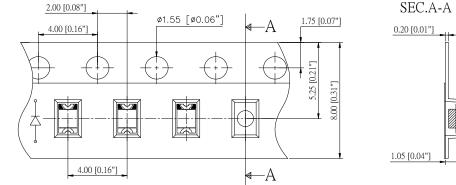
Dimensions of Reel (Unit: mm) 

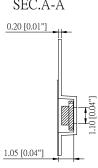




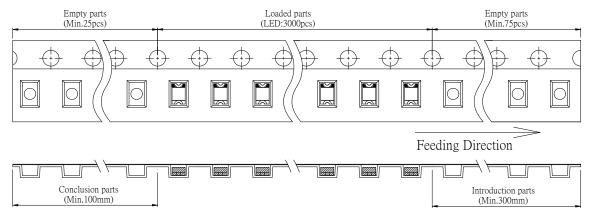


Dimensions of Tape (Unit: mm)





#### Arrangement of Tape



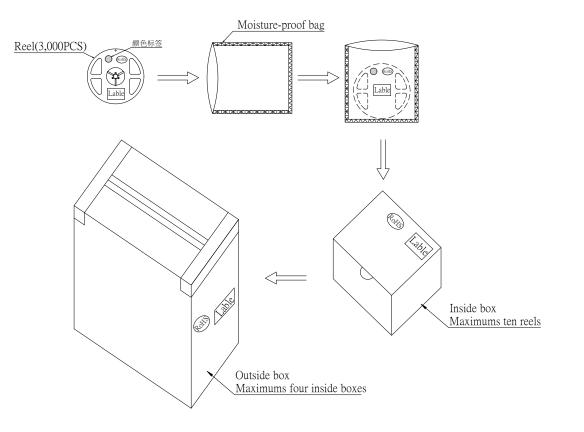
#### Notes:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
- 4. 3,000 pcs/Reel.



## 2012 Series SMD Chip LED Lamps Packaging Specifications

• Packaging specifications



Notes:

Reeled products (numbers of products are 3,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, ten moisture-proof bag of maximums (total maximum number of products are 30,000pcs) packed in an inside box (about size: 240x 220x 120mm) and four inside boxes of maximums are put in the outside box (about size: 460mm x 246mm x 250mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. and quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.